Electromagnetic theory & Interface Asima, S. RA231100401038

QI. A smartphone is causing interference with nearby wifi signals leading to degraded performance of other devices. What design modification can be implemented to reduce EMI & improve the phones compatibility with surrounding electronic Interference and improve a smartphones compatibility with surrounding electronics. These design modifications can be implemented.

\* Shielding:

Add metal shielding around components that generate significant EMI, such as power circuits and unineless transmitter. This prevents interface from affecting nearby devices & ensures the phones internal components don't interfere with each other

\* Better PCB Layout:

A good PCB layout, minimizes noise by using ground planes and placing components carefully shorter traces reduce interference, this keeps high speed signals clean A well structured PCB helps control EMI emissions. It also improves signal quality in the phone

\* Filter components:

filteres like femite beads and capacitoses reduce noise an power and signal lines. They block high frequency interference adding these components never power becomes controls EMI. This stops noise from affecting the phone & other devices.

\* Antenna design The antenna should be placed and tuned to avoid & interference with other components. proper isolation redu unwanted emissions. This also ensures strong signal reception. A good design minimizes the phone's impact on nearby electronics.

Strong grounding reduces stray currents that cause noise proper ground connections stabilize the phones circuit This controls EMI and improves performance. A sound ground system keeps interference low it also helps the phone work reliably without affecting other devices.

x spread spectrum spread spectrum techniques vary signal frequencies slightly this reduces peak EMI emissions by spreading the energy over a wider range, the interference is less concentrated This lowers the chance of the phone disrupting nearby devices

\* casing materials: Conductive coatings on metal cases help block EMI

These materials prevent interference from escaping or entering the prione this keeps internal circuits protected and reduces external noise good casing moderials reduce the phones impact on nearby electronics.

we metals shields around high power components like the motor controller and inventers this blocks EMI from reaching sensitive electronics like senson and systems, protecting them from interference

\* filter components:

Add filters (capacitosis, inductors, femite beads) on fewer and signal lines to reduce high frequencies noise these filters help isolate sensitive electronics from the woise high power systems.

\* Grounding and Sounding

Ensure a sould grounding system by connecting all

pasts to a single ground point. this reduces ground

coops and helps control EMI keeping interférence ion

in the vehicle's system.

\* Cable management:

Keep high power cables seperate from low power signal wines to reduce interference. Use twisted pair and suicided cables to prevent EMI from travelling along wires.

\* improved PCB design.

Design PCB's when ground planes and keep signal trace!

Short placing sensitive circuits away from high power

eira prevents EMI from affecting contorol systems.

\* Soft switching techniques:

use soft switching in power systems to reduce EMI V during switching events. this minimizes sudden voltage & current changes, which are major sowice systems.

\* Active EMI suppression:

Use systems that detect & cancel EMI by generating counteracting signals. this can significantly reduce noise in highly noisy environments.

\* components selection:

choose components like low-noise transistors & power conventor that one rated for high EMC performance, reducing the EMI generated by the component themselves.

\* chassis as shielding:

The vehicles metal body can act as a suield, preventing EMI from escaping or entering the systems

\* EMC testing:

Regular testing for EMC compliance help identify & file issues early ensuring the vehicle meets required standards & operates reliably without interference.

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Mediation and EM radiation in the space. What considerations can be implemented to ensure

Jo ensure reliable communication & nun EMI in a satellismmunication system.

keypoints of issue:

- i) Design wonsiderations for space environment
- 2) Radiation hardening
- 3) stillding
- 4) Grounding
- 5) fileering
- 6) Redundancy

\* Design considerations:

- radiation environment of space
- implementing effective temperature conterol mechanisms to prevent component failure
- Designing the component of satellite to withstand the mechanical stresses of launch & operation in space.

   Radiation can cause evosus in electronic circuits leading to bitfups Radiation hardened components are essential to present bitfups.

\* Redundation

- implementing redundant systems to ensure continued operations in case of component failure.
- bittips caused by noise on interference.

- It can reduce effects caused by bifflips & EMI-or ) other factoris.
- to protect sensitive electronic components from ext EMI & to prevent satellite from emitting excess EMI.
- \* Methods:
- using skielded cables for all int connections.
- \* filtoung \* filtoung - to attennate communited frequencies in EM spectrum especially by those generated by satellite power systems requirement.
- \* Methods:
- \* Methods:
   Using combination of inductors & capacitors to filter high-frequency noise.
- employing fitters to reduce noise à harmonies generated big power supply.
- using filders to alternate unwanted frequencies in comm. equipment.
- rentioned parameters, I think this issue can be desolved.

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